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INFORMATION DISCHOOL SURE	Application Number	10/038,084
STATEMENT BY APPLICANT	Filing Date	January 3, 2002
(use as many sheets as necessary)	Confirmation Number	7363
	First Named Inventor	Robert J. Falster
	Group Art Unit	2811
	Examiner Name	
Sheet 1 of 10	Attorney Docket No.	MEMC 98-3052 (2512.2)

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^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹Unique citation designation number. ²See attached Kinds of U.S. Patent Documents. ³Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶Applicant is to place a check mark here if English language Translation is attached.

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				First Named Inventor	Robert J. Falster		
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Sheet	2	of	10	Attorney Docket No.	MEMC 98-3052 (2512.2)		

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*Unique citation designation number. *See attached Kinds of U.S. Patent Documents. *Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). *For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. *Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. *Applicant is to place a check mark here if English language Translation is attached.

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Sheet	4	of	10	Attorney Docket No.	MEMC 98-3052 (2512.2)		

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Sheet	5	of	10	Attorney Docket No.	MEMC 98-3052 (2512.2)		

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				First Named Inventor	Robert J. Falster		
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¹Unique citation designation number. ²See attached Kinds of U.S. Patent Documents. ³Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶Applicant is to place a check mark here if English language Translation is attached.

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INI	FORMATION	DIST	ALESURE.	Application Number	09/737,715		
	ATEMENT B			Filing Date	December 15, 2000		
(use	as many shee	ets as	necessary)	Confirmation Number	9249		
				First Named Inventor	Robert J. Falster		
				Group Art Unit			
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l in	FORMATION	DISC	LOSHBENNA O	Application Number	09/737,715	
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	e e e e e e e e e	,		First Named Inventor	Robert J. Falster	
				Group Art Unit		
				Examiner Name		
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